

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	29680	interference adj (ring pattern fringe)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/11 15:10
S2	112355	trench	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/11 15:10
S3	2345484	wafer substrate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/11 15:11
S4	460	S1 and S2 and S3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/11 15:11
S5	5850566	uniform parallel (normal near surface) flat smooth	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/11 15:13
S6	400	S4 and S5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/11 15:15
S7	68	S2 same S1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/11 17:24
S8	184272	Fib milling	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/11 17:24

## EAST Search History

S9	3	S7 and S8	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 06:40
S10	29700	interference adj (ring pattern fringe)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 06:41
S11	112515	trench	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 06:41
S12	68	S11 same S10	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 06:41
S13	68	S12	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 07:06
S14	2585402	compensating compensate adjust adjusting	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 06:42
S15	31	S13 and S14	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 06:42
S16	20	S13 and (3D three near1 (dimensional dimension))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 07:15

## EAST Search History

S17	6	S13 and contour	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 08:36
S18	8	chemically adj assisted near4 (FIB FIBE)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 08:37
S19	6	S18 and trench	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 13:43
S20	13	computerized same fib	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 13:45
S21	13	(computerized computer adj controled) same fib	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 13:46
S22	28	(computerized computer adj controlled) same fib	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/12 13:56
S23	1	("6225626").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2006/01/12 13:56
S24	334478	("257").CLAS.	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2006/01/13 12:20
S25	210010	S24 and @py<"2000"	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2006/01/13 12:22

## EAST Search History

S26	1325	257/691.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2006/01/13 12:20
S27	9528	257/691.ccls. 257/676.ccls. 257/778. ccls. 257/666.ccls. 257/673.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2006/01/13 12:22
S28	4831	S27 and @py<"2000"	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2006/01/13 12:23
S29	4481	S27 and @py<"1999"	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2006/01/13 12:24
S32	37697	lead adj frame	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2006/01/13 12:31
S33	537953	pad	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	ON	2006/01/13 12:32
S34	2758822	via through adj hole	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	ON	2006/01/13 12:32
S35	338	S29 and S32 and S33 and S34	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	ON	2006/01/13 12:38
S36	0	die adj attach adj "platform.clm"	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2006/01/13 12:39
S37	0	lead adj "frame.clm"	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2006/01/13 12:39
S38	0	lead adj "frame.clm."	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2006/01/13 12:39
S39	0	lead adj "frame.clms."	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2006/01/13 12:40

## EAST Search History

S40	68848	mask.CLM.	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2006/01/13 12:40
S41	5863	lead adj frame.CLM.	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2006/01/13 12:40
S42	1	die adj attach adj platform.CLM.	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2006/01/13 12:42
S43	69707	chip.CLM.	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2006/01/13 12:42
S44	0	solder adj "ball.CLM"	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2006/01/13 12:42
S45	0	solder adj "ball.CLM."	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2006/01/13 12:42
S46	4427	solder adj ball.CLM.	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2006/01/13 12:42
S47	1	S46 and S43 and S41 and S40 and @py<"1999"	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2006/01/13 12:44